

|              | LEC              | LED Chip        |                 |  |
|--------------|------------------|-----------------|-----------------|--|
| Ant Part No. | Material         | Emitting Colour |                 |  |
| 703-1043     | AlGaInP/Sapphire | White           | Yellow Diffused |  |

### Absolute Maximum Ratings at Ta=25°C:

| Parameter  | Symbol    | Rating   | Unit |
|--|-----------|--|------|
| Power Dissipation*                               | PD        | 120  | mW   |
| Reverse Voltage*                                 | VR        | 5  | V    |
| D.C. Forward Current*                            | If        | 30   | mA   |
| Peak Current (½ Duty Cycle, 0.1 ms Pulse Width)* | If (Peak) | 100  | mA   |
| Operating Temperature Range                      | Topr.     | -40 to +100  | °C   |
| Storage Temperature Range                        | Tstg.     | -40 to +100  | °C   |
| Soldering Temperature                            | Tsld.     | Dip Soldering: 260°C for 10sec.<br>Hand Soldering: 350°C for 3sec. |      |
| Electric Static Discharge Threshold (HBM)*       | ESD       | 6000   | V    |

<sup>\*</sup>The values are based on 1 die performance.

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### **Electrical & Optical Characteristics:**

| Parameter                                      |    | Complete       | Condition                 | Value |      |      | Hait |
|--|----|----------------|---------------------------|-------|------|------|------|
|  |    | Symbol         | Symbol Condition          | Min.  | Тур. | Max. | Unit |
| Luminous Intensity*2                           |    | lv             | IF=20 mA*1                | 6000  | 7500 | -    | mcd  |
| Luminous Flux* <sup>2</sup>                    |    | Ф٧             | IF=20 mA*1                | -     | 15   | -    | mlm  |
| Forward Voltage*2                              |    | Vf             | IF = 20 mA*1              | -     | 3.2  | 4.0  | V    |
| Correlated Colour<br>Temperature* <sup>2</sup> | WE |                |                           | 6000  | -    | 6250 |      |
|  | WF |                | $IF = 20  \text{mA}^{*1}$ | 6250  | -    | 6500 | L/   |
|  | WG | CCT            | IF = 20 mA**              | 6500  | -    | 6750 | K    |
|  | WH |                |                           | 6750  | -    | 7000 |      |
| Colour Rendering Index (RA)                    |    | CRI            | IF=20 mA                  | -     | 95   | -    | Ra   |
| Reverse Current*1                              |    | l <sub>R</sub> | Vr=5V*1                   | -     | -    | 50   | μΑ   |
| View Angle*2                                   |    | 201/2          | IF = 20 mA*1              | -     | 120  | -    | deg  |

Notes: 1. The data is tested by an IS tester.
2. Customer's special requirements are also welcome.
3. \*1 for each die.
4. \*2 when all LED dies are operated simultaneously.

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### **Typical Electrical / Optical Characteristic Curves:**

(25°C Ambient Temperature unless otherwise noted)

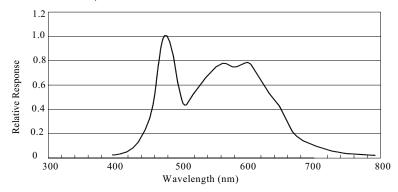
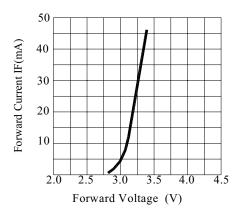
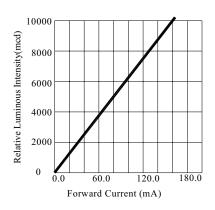
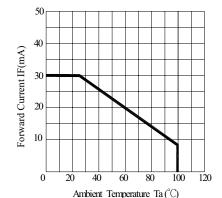


Fig.1 WHITE LED Spectrum VS. WAVELENGTH

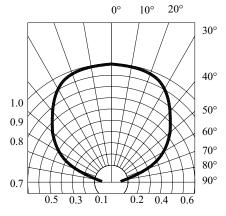




Forward Current VS. Applied Voltage



Forward Current VS. Luminous Intensity



Ambient Temperature VS. Forward Current

**Radiation Diagram** 

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#### Storage:

Recommended storage environment:

- Temperature: 5°C ~ 30°C (41°F ~ 86°F)
- Humidity: 60% RH Max.
- Moisture measures: Please refer to Moisture-sensitive label on reels package bags. If unused LEDs remain, they should be stored in moisture proof packages, such as a sealed container with packages of moisture absorbant material (silica gel). It is also recommended to return the LEDs to the original moisture proof bag and to reseal it again (fold the open bag firmly shut and keep in a dry environment

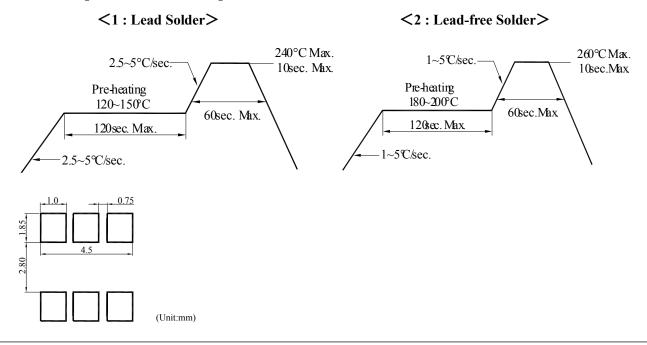
### Soldering:

| Reflow Soldering |                                    |                                    | Ha             | Hand Soldering             |  |
|------------------|------------------------------------|------------------------------------|----------------|----------------------------|--|
|                  | Lead Solder                        | Lead-free Solder                   |                |                            |  |
| Pre-heat         | 120∼150°C                          | 180∼200°C                          | Temperature    | 350°C Max.                 |  |
| Pre-heat Time    | 120sec. Max.                       | 120sec. Max.                       | Soldering Time |                            |  |
| Peak Temperature | 240°C Max.                         | 260°C Max.                         |                |                            |  |
| Soldering Time   | 10sec. max.                        | 10sec. Max.                        |                | 3sec. Max. (one time only) |  |
| Condition        | Refer to Temperature-<br>profile 1 | Refer to Temperature-<br>profile 2 |                |                            |  |

<sup>\*</sup> After reflow soldering rapid cooling should be avoided.

#### Temperature-profile (Surface of circuit board):

Use the following conditions shown in the figure.



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